

产品描述:

TM3B015I60D6V2-01VA是一款 600V/15A 三相全桥智能功率模块，内置了低损耗沟槽栅场截止型 IGBT 和FRD，内部集成了自举二极管 BSD，简化了客户的 PCB 设计。内部集成温度输出 VOT 功能用于检测模块内部的温度。集成欠压保护，过流保护，过温保护。

Description

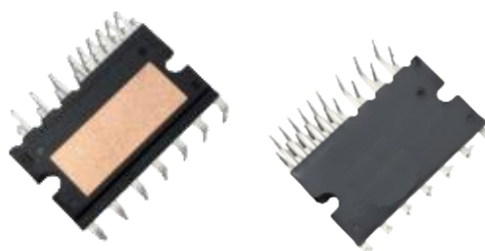
TM3B015I60D6V2-01VA is a 600V/15A three-phase full-bridge intelligent power module (IPM). The module integrates low-loss trench-gate field-stop IGBTs and fast recovery diodes (FRD), as well as bootstrap diodes(BSD) to significantly simplify customer PCB design. It features a built-in temperature output function (VOT)for real-time internal temperature monitoring, and provides multiple protection functions including under-voltage protection (UVP), over-current protection (OCP) and over-temperature protection (OTP), which comprehensively improves system reliability.

主要特点:**MAIN FUNCTION AND RATING**

- 集成 6 颗低损耗 IGBT (600V/15A)
- Integrated 6 low-loss IGBTs (600V/15A)
- 集成高压栅极驱动电路 (HVIC)
- Integrated high voltage gate drive circuit(HVIC)
- 内置欠压保护、过温保护、过流保护及温度输出功能
- Built-in under voltage protection and over temperature, over current protection and temperature output
- 内置带限流电阻的快速恢复自举二极管
- Built-in fast recovery bootstrap diode with current limiting resistor
- 绝缘等级: 2000Vrms / 分钟
- Insulation class 2000Vrms / min
- 高可靠性、热稳定性好、参数一致性佳
- High reliability and thermal stability, good parameter consistency

应用:**APPLICATION**

- 变频空调压缩机驱动
- Inverter air-conditioning compressor drive
- 工业伺服变频器
- Industrial servo converter
- 大功率风机、水泵
- High power inverter's fan and water pump
- 电机驱动器
- Motor driver

**封装/Package: DIP26****订购信息Ordering Information**

产品型号 Part Number	封装形式 Package	包装方式 Shipping
TM3B015I60D6V2-01VA	DIP26	条管 Tube

内部等效电路/管脚说明

Internal Equivalent Circuit/Pin Configuration

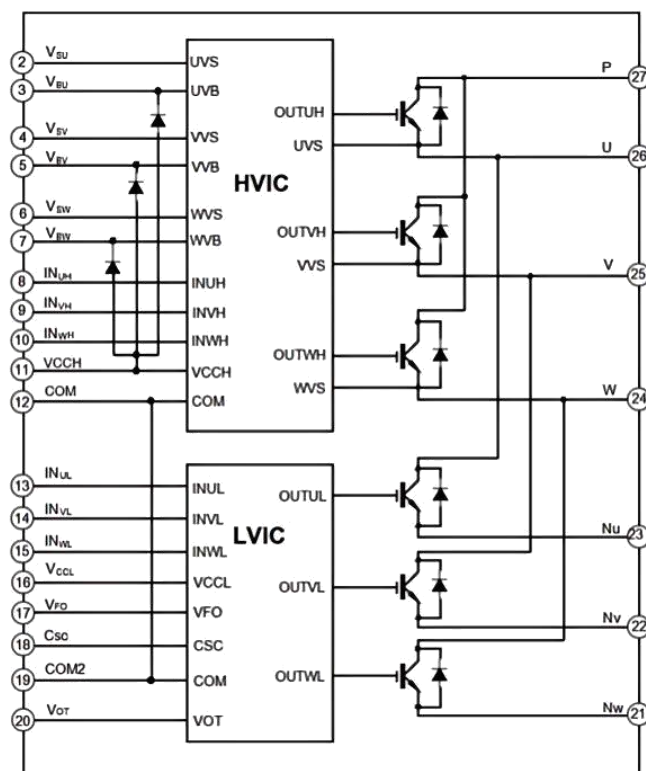


图 1：内部等效电路

Fig1: Internal Equivalent Circuit

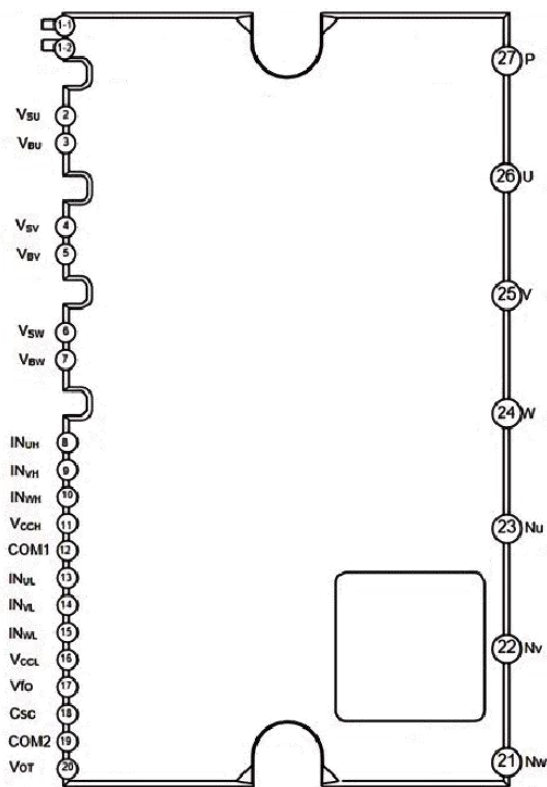


图 2：引脚定义图

Fig2: Final Equivalent Circuit

管脚定义/Pin Descriptions

管脚编号 Pin Number	管脚名称 Pin Name	管脚描述 Pin Descriptions
(1-1)	COM	内部公共接地端, 无连接 Internal common ground terminal, No Connection
(1-2)	V _{CC}	内部电源端, 无连接 Internal power terminal, No Connection
2	V _{SU}	U 相上桥悬浮地供电电压 U-phase high side floating ground supply voltage
3	V _{BU}	U 相上桥驱动悬浮供电电压 U-phase high side floating IC supply voltage
4	V _{SV}	V 相上桥悬浮地供电电压 V-phase high side floating ground supply voltage
5	V _{BV}	V 相上桥驱动悬浮供电电压 V-phase high side floating IC supply voltage
6	V _{SW}	W 相上桥悬浮地供电电压 W-phase high side floating ground supply voltage
7	V _{BW}	W 相上桥驱动悬浮供电电压 W-phase high side floating IC supply voltage
8	IN _{UH}	U 相上桥栅极驱动器输入 U-phase high side gate driver input

9	IN _{VH}	V 相上桥栅极驱动器输入 V-phase high side gate driver input
10	IN _{WH}	W 相上桥栅极驱动器输入 W-phase high side gate driver input
11	V _{CCH}	上桥栅极驱动供电电压 High side gate drive supply voltage
12	COM1	模块公共接地端 Module common ground
13	IN _{UL}	U 相下桥栅极驱动器输入 U-phase low side gate driver input
14	IN _{VL}	V 相下桥栅极驱动器输入 V-phase low side gate driver input
15	IN _{WL}	W 相下桥栅极驱动器输入 W-phase low side gate driver input
16	V _{CCL}	下桥栅极驱动供电电压 Low side gate drive supply voltage
17	V _{FO}	故障信号输出端 Fault Output
18	C _{SC}	外接电容端，用于短路电流检测输入与低通滤波 External capacitor, used for short-circuit current detection input and low-pass filtering
19	COM2	模块公共接地端 Module common ground
20	V _{OT}	温度信号输出端 Temperature output terminal
21	N _W	W 相直流负端 W-phase DC negative terminal
22	N _V	V 相直流负端 V-phase DC negative terminal
23	N _U	U 相直流负端 U-phase DC negative terminal
24	W	W 相输出端 Output for W Phase
25	V	V 相输出端 Output for V Phase
26	U	U 相输出端 Output for U Phase
27	P	直流母线正极输入端 Positive DC-Link Input

最大额定值 ($T_c = 25^\circ\text{C}$, 除非特殊说明)

Maximum Ratings ($T_c = 25^\circ\text{C}$ Unless Otherwise Specified)

逆变部分/Inverter Part

符号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Unit
V_{PN}	电源电压 Supply Voltage	施加于 P - NU、NV、NW 之间 Applied between P-NU, NV, NW	450	V
$V_{PN}(\text{surge})$	电源电压 (含浪涌) Supply Voltage (Surge)	施加于 P - NU、NV、NW 之间 Applied between P - NU, NV, NW	500	V
V_{CE}	集电极 - 发射极电压 Collector-Emitter Voltage		600	V
I_{CE}	集电极电流 Each IGBT Collector Current	$T_c=25^\circ\text{C}$, $T_j \leq 150^\circ\text{C}$	15	A
I_{CP}	集电极峰值电流 Each IGBT Collector Current (Peak)	$T_c=25^\circ\text{C}$ $T_j \leq 150^\circ\text{C}$	30	A
P_D	芯片功耗 Power dissipation per one chip	$T_c=25^\circ\text{C}$	35	W

控制部分/Control(Protection) Part

符号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Unit
V_{CC}	控制电源电压 Control the supply voltage	应用于 V_{CCH} -COM1 COM2, V_{CCL} -COM1 COM2 之间 Applied between VCCH-COM1 COM2, VCCL-COM1 COM2	20	V
V_{BS}	高侧控制电压 High-side control voltage	应用于 V_{BU} -U, V_{BV} -V, V_{BW} -W 之间 Applied between V_{BU} -U, V_{BV} -V, V_{BW} -W	20	V
V_{IN}	输入信号电压 Input signal voltage	应用于 IN_{UH} , IN_{VH} , IN_{WH} , IN_{UL} , IN_{VL} , IN_{WL} -COM 之间 Applied between IN_{UH} , IN_{VH} , IN_{WH} , IN_{UL} , IN_{VL} , IN_{WL} -COM	$-0.3 \sim V_{CC}+0.3$	V
V_{FO}	故障输出电源电压 Fault output supply voltage	应用于 V_{FO} -COM 之间 Applied between V_{FO} -COM	$-0.3 \sim V_{CC}+0.3$	V
T_J	工作结温范围 Operating junction temperature range		-40 to 150	$^\circ\text{C}$
T_c	工作壳温范围 (结温 $\leq 150^\circ\text{C}$) Working shell temperature range, $T_J \leq 150^\circ\text{C}$		-30 to 100	
T_{STG}	存储温度范围 Storage temperature range		-40 to 125	$^\circ\text{C}$

$R_{\theta_{JCQ}}$	单 IGBT 结 - 壳热阻 Single IGBT thermal resistance, junction-case		3.5	°C/W
$R_{\theta_{JCF}}$	单 FRD 结 - 壳热阻 Single FRD thermal resistance, junction-case		3.9	°C/W
V_{ISO}	绝缘测试电压 Isolation test voltage	1 分钟, 有效值, 频率 60Hz 1min, RMS, f = 60Hz	2000	V _{rms}

备注 1: 功率芯片最高结温为 150°C。为保证智能功率模块 (IPM) 安全工作, 建议平均结温 $T_J \leq 125^\circ\text{C}$ (壳温 $T_C \leq 100^\circ\text{C}$ 条件)。

Note 1: The maximum junction temperature of the power chip is 150°C, in order to ensure that IPM can work safely, it is recommended that the average junction temperature $T_J \leq 125^\circ\text{C}$ (@ $T_C \leq 100^\circ\text{C}$)

推荐工作条件/Recommended Operation Conditions

符号 Symbol	项目 Parameter	条件 Condition	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
V_{PN}	直流母线 P- N 端供电电压 DC link supply voltage of P-N	应用于 P-UN/UV/UW 之间 Applied between P-UN/UV/UW	-	300	400	V
V_{CC}	低侧驱动电源电压 Low side supply voltage	应用于 V_{CCH} -COM 之间 Applied between V_{CCH} -COM	13.2	-	20	V
V_{BS}	高侧悬浮电源电压 (VB 对 VS) High side floating supply voltage (VB v.s VS)	应用于 V_{BU} -U, V_{BV} -V, V_{BW} -W 之间 Applied between V_{BU} -U, V_{BV} -V, V_{BW} -W	13.2	-	20	V
F_{PWM}	PWM 载波频率 PWM carrier frequency				20	kHz
DT	高侧与低侧输入间外部死区时间 External dead time between HIN & LIN		1			uS
V_{COM}	VSS- N 之间电压 (含浪涌) Voltage between VSS - N (including surge)		-5		5	V
$PW_{IN(ON)}$ $PW_{IN(OFF)}$	最小输入脉冲宽度 Minimum input pulse width		1			uS
dV_{CC}/dt dV_{BS}/dt	控制电源电压变化范围 Control supply variation		-1		1	V/uS

电气特性: (TC = 25°C, 除非特殊说明)

Electrical Characteristics (TC = 25°C Unless Otherwise Specified)

逆变部分/Inverter Part

符号 Symbol	项目 Parameter	条件 Condition	最小 值 Min	典型 值 Typ	最大 值 Max	单位 Unit
VCE(SAT)	集电极与发射极间饱和电压 Collector-emitter saturation voltage	$V_{CC}=V_{BS}=15V$, $V_{IN}=5V$ $I_C=15A$, $T_J = 25^\circ C$	-	1.75	2.1	V
VF	FRD 正向导通压降 FRD forward voltage	$V_{IN}=0V$, $I_F=15A$, $T_J = 25^\circ C$	-	1.5	2.0	V
ton	开关时间 (高侧) Switching time (high side)	$V_{PN} = 400V$, $V_{CC}=V_{BS}=15V$, $I_C = 15A$, $V_{HLIN, LIN} = 5V$, 感性负载	-	0.78	-	μs
tc(on)			-	0.33	-	μs
toff			-	0.61	-	μs
tc(off)			-	0.07	-	μs
trr			-	0.16	-	μs
ton	开关时间 (低侧) Switching time (low side)	$V_{PN} = 400V$, $V_{CC} = V_{BS} = 15V$, $I_C = 15A$, $V_{HLIN, LIN} = 5V$, Inductive load	-	0.99	-	μs
tc(on)			-	0.46	-	μs
toff			-	0.71	-	μs
tc(off)			-	0.09	-	μs
trr			-	0.03	-	μs
ICES	集电极发射极漏电流 Collector-Emitter Leakage current	$V_{CE}=600V$	-	-	1	mA

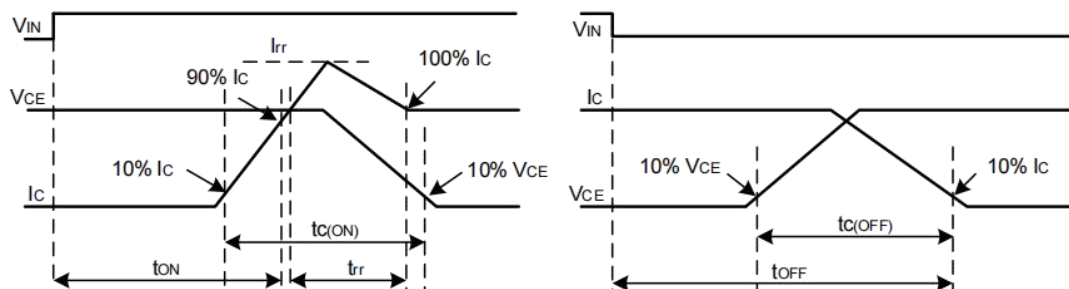


图 3. 开关时间的定义

Figure 3. Definition of switching time

控制部分/Control(Protection) Part

符号 Symbol	项目 Parameter	条件 Condition	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
I_{QCC}	控制电源静态电流 (VCC) Quiescent VCC supply current	$V_{CC}=15V, V_{IN}=0V$	-	-	2.0	mA
I_{QBS}	高侧悬浮电源静态电流 (VBS) Quiescent VBS supply current	$V_{BS}=15V, V_{IN}=0V$	-	-	200	uA
V_{FOH}	故障输出电压 Fault output voltage	$V_{SC}=0V, V_F$ 电路: 10k Ω 电阻上拉至 5v VSC=0V, VF Circuit: 10k Ω to 5V Pull-up	4.9	-	-	V
V_{FOL}		$V_{SC}=1V, I_{FO}=1mA$	-	-	0.9	V
t_{FO}	故障输出脉冲宽度 Fault output pulse width	故障持续 Fault duration	40	-	-	us
$V_{SC(ref)}$	短路保护触发电压 Short-circuit protection trigger voltage	$V_{CC}=15V$	0.42	0.48	0.54	V
OT_t	过温保护 Over temperature protection	LVIC 温度 LVIC temperature	100	120	140	° C
OT_{rh}	过温保护迟滞 Over temperature protection hysteresis	LVIC 迟滞温度 LVIC temperature Hysteresis	-	10	-	° C
V_{OT}	温度输出 (见图 4) Temperature output (Figure 4)	LVIC 温度=25°C LVIC Temperature=25 °C	1.06	1.2	1.39	V
		LVIC 温度=90°C LVIC Temperature=90 °C	2.63	2.7	2.91	V
UV_{Dt}	低侧欠压保护 (见图 7) Low-side under voltage protection (Figure 7)	V_{CC} 触发电压 VCC senses voltage	9	10	11	V
UV_{Dr}		V_{CC} 复位电压 VCC reset voltage	10	11	12	V
UV_{DBt}	高侧欠压保护 (见图 8) High-side under voltage protection (Figure 8)	V_{BS} 触发电压 VBS senses voltage	9	10	11	V
UV_{DBr}		V_{BS} 复位电压 VBS reset voltage	10	11	12	V
V_{IH}	导通阈值电压 On-threshold voltage	逻辑高电平 Logic high	-	-	2.5	V
V_{IL}	关断阈值电压 Shutdown threshold voltage	逻辑低电平 Logic low	0.8	-	-	V

自举二极管部分/Bootstrap diode section

符号 Symbol	项目 Parameter	条件 Condition	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
V_F	正向电压 Forward voltage	$I_F=10\text{mA}$, $T_C=25^\circ\text{C}$	—	2.9	—	V
R_{BSD}	BSD 限流电阻 BSD on resistor	$T_C=25^\circ\text{C}$	—	240	—	Ω

V_{OT} 输出曲线/ V_{OT} Output Curve

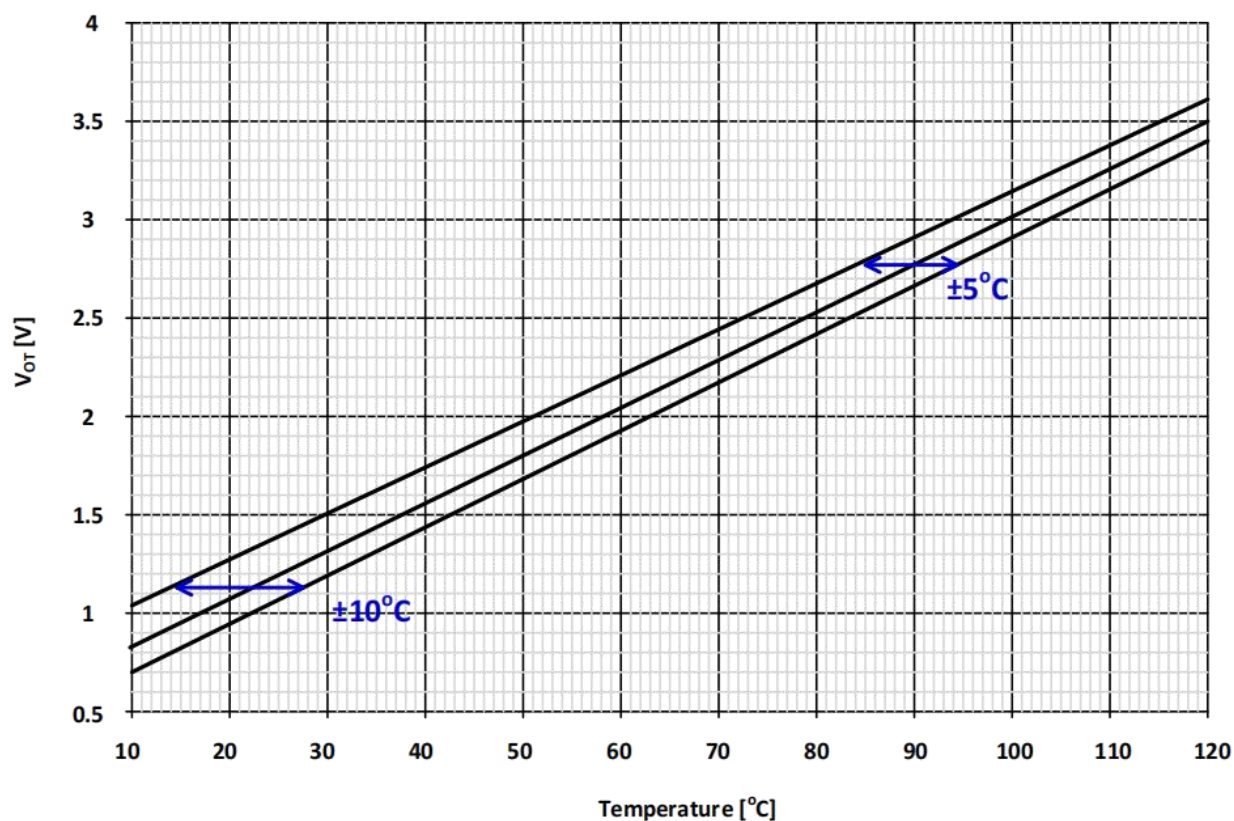


图 4: 温度- V_{OT} 特性曲线 (典型值)
Figure 4. Temperature Profile of V_{OT} (Typical)

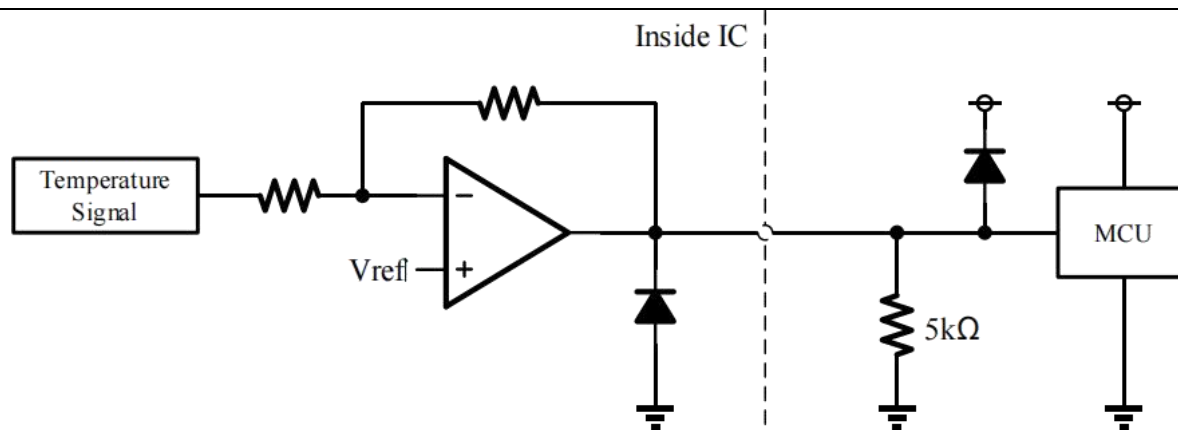


图 5: VOT 输出电路
Figure 5 VOT output circuit

1、若使用温度监测功能，请在 VOT 引脚外接 $5k\Omega$ 电阻，并禁用内部 OTP 功能；若使用内部过温关断功能，则 VOT 引脚保持悬空（不连接）。

If the temperature monitoring function is used, connect $5k\Omega$ to the VOT pin, and ignore the internal OTP function. If the internal over temperature shutdown function is used, keep the VOT pin on (no connection).

2、当 IPM 用于低压控制场景（如 MCU 工作电压为 3.3V）时，温度急剧上升情况下 VOT 输出电压可能高于 3.3V 控制电源电压。低压控制系统建议在控制电源与 VOT 输出信号之间并联钳位二极管，防止过压损坏。

When IPM is applied in low-voltage control (such as MCU working voltage of 3.3V), the output voltage of VOT may be greater than the control supply voltage of 3.3V in the case of a sharp rise in temperature, if the system is used for low-voltage control, it is recommended to connect a clamping diode between the control power supply and the VOT output signal to prevent over voltage damage.

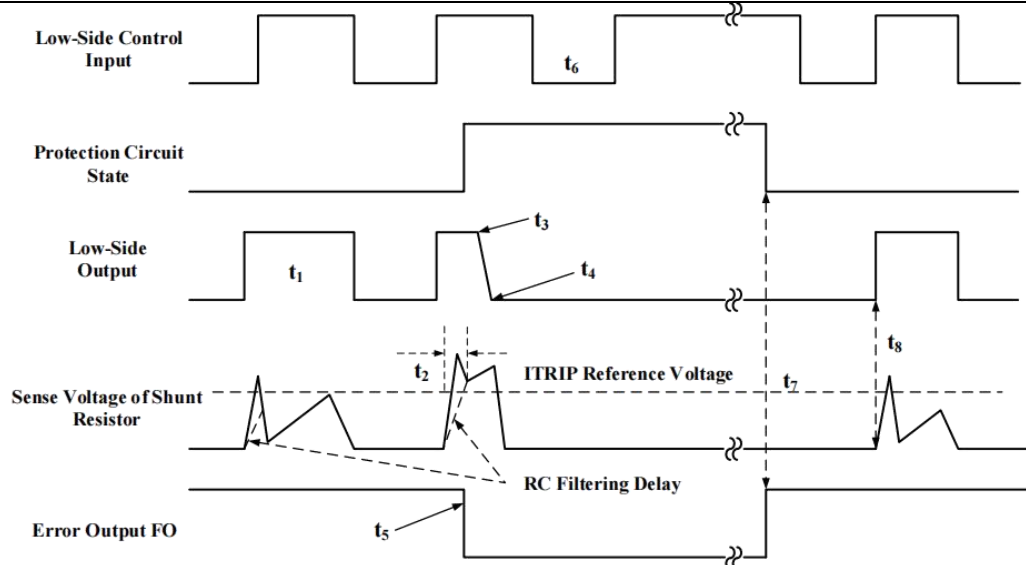


图 6：短路电流保护（仅针对下桥臂 / 低侧）

Figure 6. Short-circuit current protection (low side only)

t1: 正常工作，低侧输出导通。

t1: Normal operation, Low-Side output.

t2: 短路电流检测（ITRIP 触发）。

（建议设置 RC 时间常数为 $1.5 \sim 2.0 \mu s$ ，确保 ITRIP 触发后 IGBT 在 $2.0 \mu s$ 内关断。）

t2: Short circuit current detection (ITRIP trigger).

(It is recommended to set RC time constant $1.5 \sim 2.0 \mu s$ so that IGBT shunt down within $2.0 \mu s$ when ITRIP be triggered.)

t3: 所有低侧输出被硬中断。

t3: All low-side outputs are hard interrupted.

t4: 所有低侧输出关断。

t4: All low-side outputs turn off.

t5: FO 输出持续时间 $t_{FO} \geq 40 \mu s$ （最小值）。

t5: FO outputs for $t_{FO} = 40 \mu s$ (min).

t6: 输入为低电平，输出保持关断。

t6: Input is low, outputs turn off.

t7: FO 恢复高电平，但输出需待输入信号由低变高后方可重新导通。

t7: FO rise to high, but outputs don't turn on until input signal change low to high.

t8: 恢复正常工作，输出导通。

t8: Normal operation, outputs on.

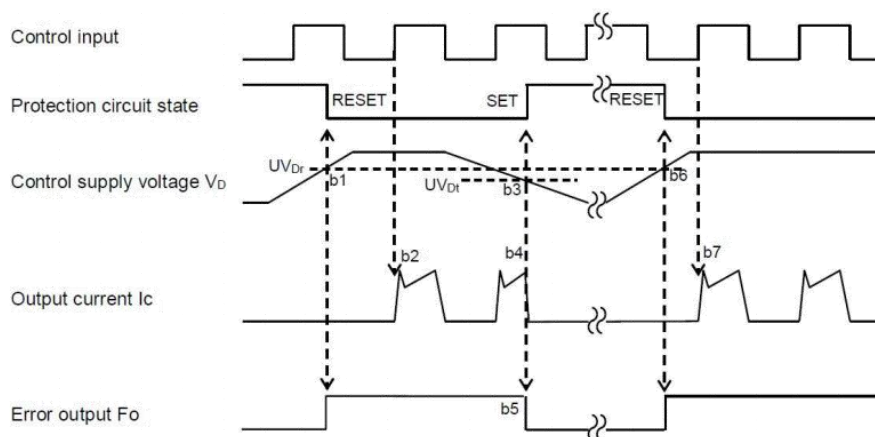


图 7：欠压保护（低侧）

Figure 7. Under voltage Protection (Low Side)

b1: 控制电源电压 V_D 高于欠压复位阈值 U_{VDr} ，在下一个输入波形到来时电路开始工作。

b1: Control supply voltage V_D exceeds under voltage reset level U_{VDr} , and the circuit starts to work when the next input waveform arrives.

b2: 正常工作：IGBT 导通并输出电流。

b2: Normal operation: IGBT ON and outputs current.

b3: V_D 电压下降至欠压动作阈值 U_{VDt} 以下。

b3: V_D level drops under voltage trip level (U_{VDt}).

b4: 无论控制输入状态如何，所有低侧 IGBT 均关断。

b4: All low side IGBTs turn off in spite of control input condition.

b5: F0 引脚输出故障信号 ($t_{FO} \geq 40 \mu s$ ，且在欠压期间持续输出故障信号)。

b5: FO pin outputs fault signal ($t_{FO} \geq 40\mu s$, and continuously outputs fault signal during under voltage).

b6: V_D 电压恢复至 U_{VDr} 。

b6: V_D level reaches U_{VDr} .

b7: 正常工作：IGBT 导通并输出电流

b7: Normal operation: IGBT ON and outputs current.

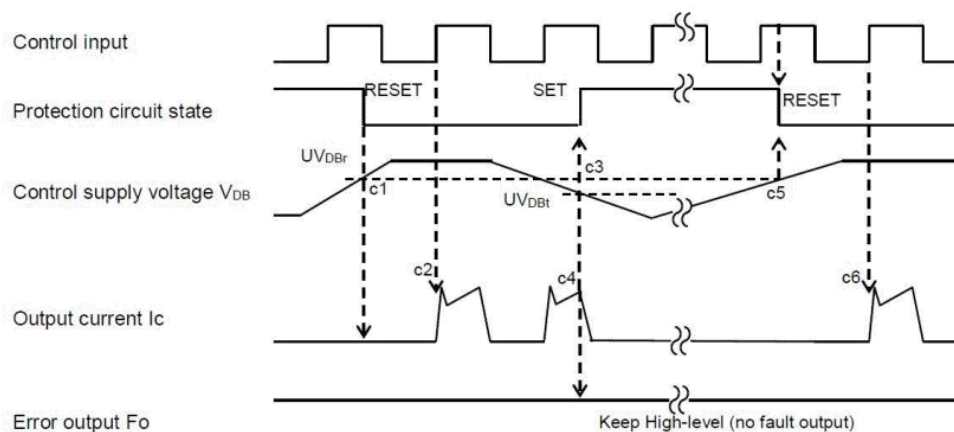


图 8: 欠压保护 (高侧)

Figure 8 Under voltage Protection (High Side)

c1: 控制电源电压 V_{DB} 上升至欠压复位阈值 UV_{DBr} , 在下一个输入信号到来时电路开始工作。

c1: Control supply voltage V_{DB} rises to UV_{DBr} , and the circuit starts to work when the next input signal arrives.

c2: 正常工作: IGBT 导通并输出电流。

c2: Normal operation: IGBT ON and outputs current.

c3: V_{DB} 电压下降至欠压动作阈值 UV_{DBt} 以下。

c3: V_{DB} level drops to under voltage trip level (UV_{DBt}).

c4: 无论输入信号如何, IGBT 均关断, 但无故障信号输出。

c4: No matter what signal input, IGBT is turned off, but there is no fault signal output.

c5: V_{DB} 电压恢复至 UV_{DBr} 。

c5: V_{DB} level reaches UV_{DBr} .

c6: 正常工作: IGBT 导通并输出电流。

c6: Normal operation: IGBT ON and outputs current.

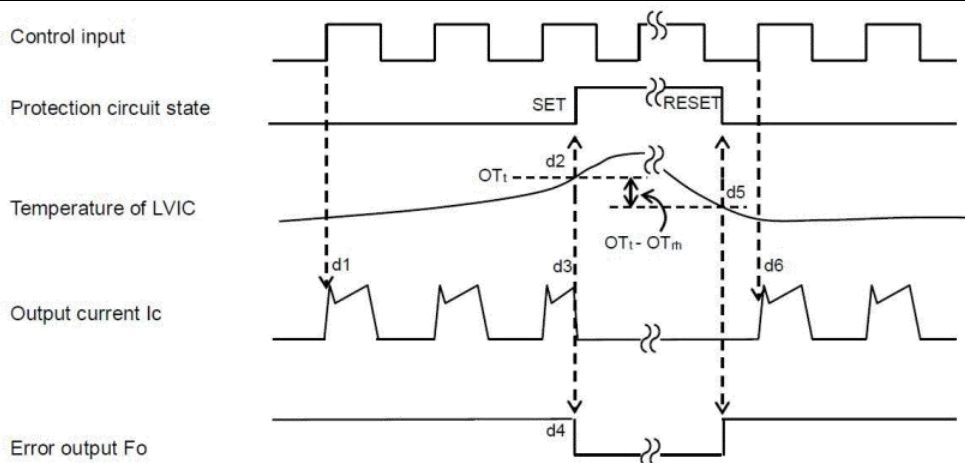


图 9：过温保护（仅低侧）

Figure 9. Over temperature protection (low side only)

- d1: 正常工作：IGBT 导通并输出电流。
d1: Normal operation: IGBT ON and outputs current.
d2: 低压集成电路（LVIC）温度超过过温保护触发阈值（OTt）。
d2: LVIC temperature exceeds the over temperature protection trigger level(OTt).
d3: 无论控制输入状态如何，所有低侧IGBT 均关断。
d3: All low side IGBTs are turned off in spite of control input condition.
d4: 过温期间持续输出故障信号，最小脉冲宽度为 40 μs。
d4: Continuously output fault signal during over temperature, and the minimum pulse width is 40us.
d5: 当温度低于过温保护复位阈值时，LVIC 复位。
d5: The LVIC will reset when the temperature is lower than the over temperature protection level.
d6: 当下一个输入控制信号到来时，IGBT 重新导通。
d6: IGBT turns on when the next input signal control signal comes.

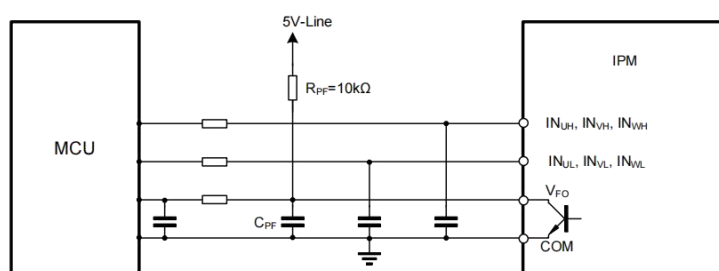


图 10：MCU 输入 / 输出连接电路（推荐方案）

Figure 10. MCU input/output connection circuit (recommended)

注意：各输入端的 RC 耦合电路需根据 PWM 控制方案及 PCB 布局进行适配。IPM 输入信号端内部集成一个 5kΩ 下拉电阻，因此在使用外部滤波电路时，需注意输入端的电压降。

Note: The RC coupling at each input should be adapted to the PWM control scheme and PCB layout. One 5K pull-down resistor is built into the IPM input signal section, so pay attention to the voltage drop at the input when using an external filter circuit.

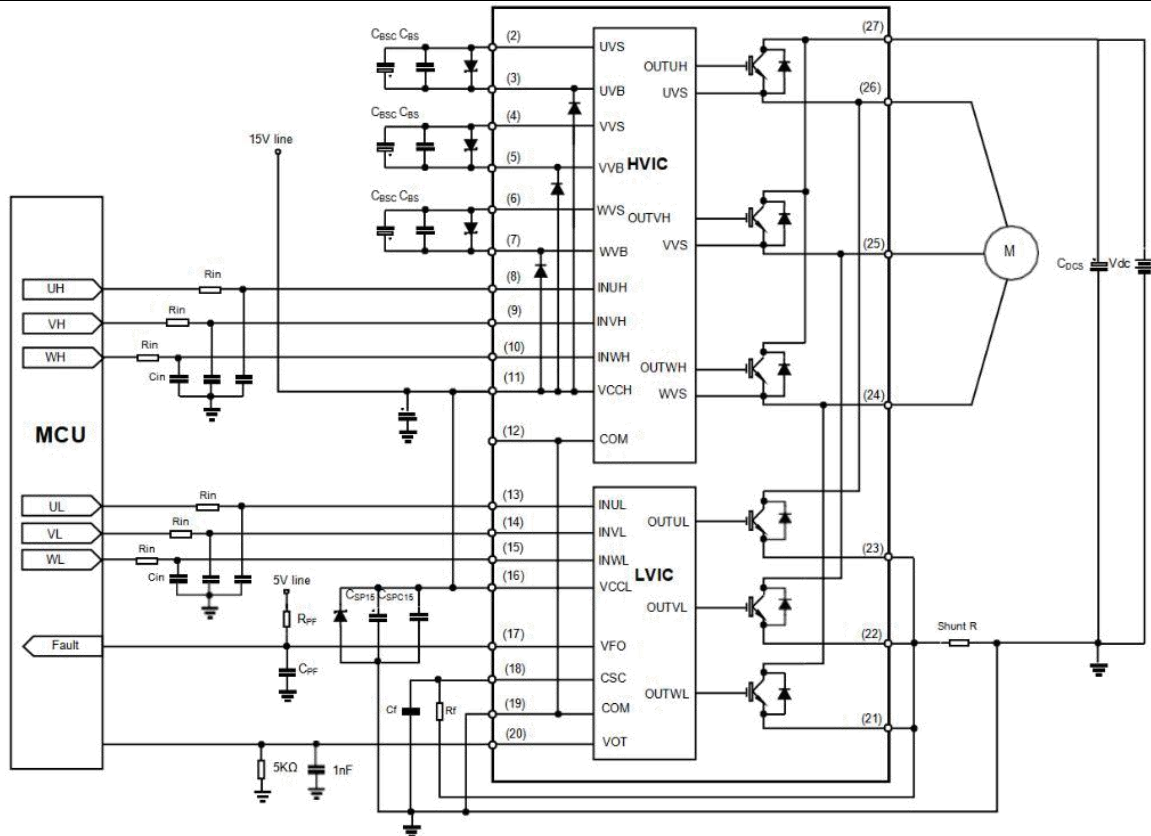


图 11: 典型应用原理图
Figure 11. Typical Application Schematic

封装外形图/Package Information

